

EAST Search History

EAST Search History (Prior Art)

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	2	("5539976").PN.	US_PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/08/03 08:59
L2	1993	(computer with assembly\$4 with circuit with board)	US_PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/08/03 09:01
L3	1310	(computer with assembly\$4 with circuit with board) and ((plac \$4 mount\$4) with (PCB CB PWB ((wiring circuit) adj board) circuitboard board))	US_PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/08/03 09:03
L4	77	(computer with assembly\$4 with circuit with board) and ((plac \$4 mount\$4) with (PCB CB PWB ((wiring circuit) adj board) circuitboard board)) and ("700"/\$ "29"/\$). ccls.	US_PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/08/03 09:05
L5	712	((computer electronic) with assembly\$4 with circuit with board) and ((plac\$4 mount\$4) with (PCB CB PWB ((wiring circuit) adj board) circuitboard board)) and ("700"/\$ "29"/\$). ccls.	US_PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/08/03 09:06

L6	227	((computer electronic) with assembly\$4 with circuit with board) and ((plac\$4 mount\$4) with (machine apparatus) with (PCB CB PWB ((wiring circuit) adj board) circuitboard board)) and ("700"/\$ "29"/\$).ccls.	US_PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/08/03 09:07
L7	53	((computer electronic) with assembly\$4 with (PCB CB PWB ((wiring circuit) adj board) circuitboard board)) and ((plac\$4 mount\$4) with (machine apparatus) with (PCB CB PWB ((wiring circuit) adj board) circuitboard board)) and ("700"/\$ "29"/\$).ccls. and camera	US_PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/08/03 09:11
L8	6	((Konrath with Willibald) (Haiko with Schmelcher)).in. and (manufactur\$4 with high with frequency)	US_PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/08/03 10:10
L9	11138	(ERICSSON MARCONI).as.	US_PGPUB; USPAT	OR	ON	2009/08/03 10:10
L10	775	700/95.ccls.	US_PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/08/03 10:10
L11	1104	700/108.ccls.	US_PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/08/03 10:10
L12	518	700/109.ccls.	US_PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/08/03 10:10

L13	739	700/110.ccls.	US_PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/08/03 10:10
L14	2379	700/121.ccls.	US_PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/08/03 10:10
L15	618	702/81.ccls.	US_PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/08/03 10:10
L16	306	702/82.ccls.	US_PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/08/03 10:10
L17	187	702/83.ccls.	US_PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/08/03 10:10
L18	565	702/84.ccls.	US_PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/08/03 10:10
L19	2405	702/182.ccls.	US_PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/08/03 10:10
L20	1707	702/183.ccls.	US_PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/08/03 10:10

L21	604	702/184.ccls.	US_PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/08/03 10:10
L22	900	702/185.ccls.	US_PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/08/03 10:10
L23	31	(L10 L11 L12 L13 L14 L15 L16 L17 L18 L19 L20 L21 L22) and (manufactur\$4 with high with frequency)	US_PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/08/03 10:10
S1	20	((Konrath with Willibald) (Haiko with Schmelcher)).in.	US_PGPUB; USPAT	OR	ON	2008/09/15 11:38
S2	10208	(ERICSSON MARCONI). as.	US_PGPUB; USPAT	OR	ON	2008/09/15 11:38
S3	2	("6938335").PN.	US_PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/09/15 11:40
S4	5	((Konrath with Willibald) (Haiko with Schmelcher)).in. and (manufactur\$4 with high with frequency)	US_PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/09/15 11:42
S5	736	700/95.ccls.	US_PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/09/15 11:54
S6	1014	700/108.ccls.	US_PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/09/15 11:54

S7	472	700/109.ccls.	US_PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/09/15 11:54
S8	645	700/110.ccls.	US_PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/09/15 11:54
S9	2188	700/121.ccls.	US_PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/09/15 11:54
S10	547	702/81.ccls.	US_PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/09/15 11:54
S11	265	702/82.ccls.	US_PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/09/15 11:54
S12	165	702/83.ccls.	US_PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/09/15 11:54
S13	541	702/84.ccls.	US_PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/09/15 11:54
S14	2164	702/182.ccls.	US_PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/09/15 11:54

S15	1528	702/183.ccls.	US_PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/09/15 11:54
S16	537	702/184.ccls.	US_PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/09/15 11:54
S17	825	702/185.ccls.	US_PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/09/15 11:54
S18	18493	(manufactur\$4 with high with frequency)	US_PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/09/15 11:55
S19	30	(S5 S6 S7 S8 S9 S10 S11 S12 S13 S14 S15 S16 S17) and (manufactur\$4 with high with frequency)	US_PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/09/15 12:08
S20	754	700/95.ccls.	US_PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/01/29 14:34
S21	1052	700/108.ccls.	US_PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/01/29 14:34
S22	494	700/109.ccls.	US_PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/01/29 14:34

S23	678	700/110.ccls.	US_PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/01/29 14:34
S24	2276	700/121.ccls.	US_PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/01/29 14:34
S25	577	702/81.ccls.	US_PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/01/29 14:34
S26	286	702/82.ccls.	US_PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/01/29 14:34
S27	175	702/83.ccls.	US_PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/01/29 14:34
S28	553	702/84.ccls.	US_PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/01/29 14:34
S29	2247	702/182.ccls.	US_PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/01/29 14:34
S30	1590	702/183.ccls.	US_PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/01/29 14:34

S31	561	702/184.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/01/29 14:34
S32	852	702/185.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/01/29 14:34
S33	3433	((assembl\$4 fabricat\$4 production manufactur\$4) with high with frequency) and ((microstrip with filter) (waveguide with junction) resonator)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/01/29 15:23
S34	734	((assembl\$4 fabricat\$4 production manufactur\$4) with high with frequency) and ((microstrip with filter) (waveguide with junction) resonator) and (assembl\$4 with high with frequency)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/01/29 15:26
S35	179	((assembl\$4 fabricat\$4 production manufactur\$4) with high with frequency) and ((microstrip with filter) (waveguide with junction) resonator) and (assembl\$4 with high with frequency) and (PCB CB PWB ((wiring circuit) adj board) circuitboard bore)	US-PGPUB; USPAT	OR	ON	2009/01/29 15:46
S36	142	((assembl\$4 fabricat\$4 production manufactur\$4) with high with frequency) and ((microstrip with filter) (waveguide with junction) resonator) and (assembl\$4 with high with frequency) and (PCB CB PWB ((wiring circuit) adj board) circuitboard)	US-PGPUB; USPAT	OR	ON	2009/01/29 15:53

S37	67	((assembl\$4 fabricat\$4 production manufactur\$4) with high with frequency) and ((microstrip with filter) (waveguide with junction) resonator) and (assembl\$4 with high with frequency) and (PCB CB PWB ((wiring circuit) adj board) circuitboard) and (assembl\$4 fabricat\$4 production manufactur\$4).ab.	US-PGPUB; USPAT	OR	ON	2009/01/29 16:02
S38	31	((assembl\$4 fabricat\$4 production manufactur\$4) with high with frequency) and ((microstrip with filter) (waveguide with junction) resonator) and (assembl\$4 with high with frequency) and (PCB CB PWB ((wiring circuit) adj board) circuitboard) and (assembl\$4 fabricat\$4 production manufactur\$4).bsum. and ((check\$4 accept \$4 reject\$4 confirm\$9 verif\$9 correct\$4 proper \$4 approv\$7) with (conduct\$4 material))	US-PGPUB; USPAT	OR	ON	2009/01/29 16:53
S39	26	((assembl\$4 fabricat\$4 production manufactur\$4) with high with frequency) and ((microstrip with filter) (waveguide with junction) resonator) and (assembl\$4 with high with frequency) and (PCB CB PWB ((wiring circuit) adj board) circuitboard) and (assembl\$4 fabricat\$4 production manufactur\$4).bsum. and ((check\$4 accept \$4 reject\$4 confirm\$9 verif\$9 correct\$4 proper \$4 approv\$7) with	US-PGPUB; USPAT	OR	ON	2009/01/29 16:53

		(conduct\$4 material) not \$37				
S40	467	((assembl\$4 fabricat\$4 production manufactur\$4) with high with frequency) and (assembl\$4 with high with frequency) and (PCB CB PWB ((wiring circuit) adj board) circuitboard) and (assembl\$4 fabricat\$4 production manufactur\$4).bsum. and ((check\$4 accept\$4 reject\$4 confirm\$9 verif\$9 correct\$4 proper\$4 approv\$7) with (conduct\$4 material)) not \$37	US-PGPUB; USPAT	OR	ON	2009/01/29 16:54
S41	212	((assembl\$4 fabricat\$4 production manufactur\$4) with high with frequency) and (assembl\$4 with high with frequency) and (PCB CB PWB ((wiring circuit) adj board) circuitboard) and (assembl\$4 fabricat\$4 production manufactur\$4).ab. and ((check\$4 accept\$4 reject\$4 confirm\$9 verif\$9 correct\$4 proper\$4 approv\$7) with (conduct\$4 material)) not \$37	US-PGPUB; USPAT	OR	ON	2009/01/29 16:54
S42	8	((assembl\$4 fabricat\$4 production manufactur\$4) same (high with frequency) and (assembl\$4 with high with frequency) and (PCB CB PWB ((wiring circuit) adj board) circuitboard) and ((check\$4 accept\$4 reject\$4 confirm\$9 verif\$9 correct\$4 proper\$4 approv\$7) with (conduct\$4 material)) and ("703"/\$ "702"/\$ "716"/\$ "700"/\$).ccls.	US-PGPUB; USPAT	OR	ON	2009/01/29 17:00

S43	21	((assembl\$4 fabricat\$4 production manufactur\$4) with (high with frequency)) and (PCB CB PWB ((wiring circuit) adj board) circuitboard) and ((check\$4 accept\$4 reject\$4 confirm\$9 verif\$9 correct\$4 proper\$4 approv\$7) with (conduct\$4 material)) and ("703"/\$ "702"/\$ "716"/\$ "700"/\$).ccls.	US-PGPUB; USPAT	OR	ON	2009/01/29 17:03
S44	57	((assembl\$4 fabricat\$4 production manufactur\$4 design\$4) with (high with frequency)) and (PCB CB PWB ((wiring circuit) adj board) circuitboard) and ((check\$4 accept\$4 reject\$4 confirm\$9 verif\$9 correct\$4 proper\$4 approv\$7) with (conduct\$4 material)) and ("703"/\$ "702"/\$ "716"/\$ "700"/\$).ccls.	US-PGPUB; USPAT	OR	ON	2009/01/29 17:08
S45	36	((assembl\$4 fabricat\$4 production manufactur\$4 design\$4) with (high with frequency)) and (PCB CB PWB ((wiring circuit) adj board) circuitboard) and ((check\$4 accept\$4 reject\$4 confirm\$9 verif\$9 correct\$4 proper\$4 approv\$7) with (conduct\$4 material)) and ("703"/\$ "702"/\$ "716"/\$ "700"/\$).ccls. not (S42 S43)	US-PGPUB; USPAT	OR	ON	2009/01/29 17:09

S46	155	((assembl\$4 fabricat\$4 production manufactur\$4) with (high with frequency)).ab. and ((PCB CB PWB ((wiring circuit) adj board) circuitboard) and ((check\$4 accept\$4 reject\$4 confirm\$9 verif\$9 correct\$4 proper\$4 approv\$7 inspect\$4 camera scan\$4) with (conduct\$4 material properties characteristics))	US-PGPUB; USPAT	OR	ON	2009/01/29 17:17
S47	2	((assembl\$4 fabricat\$4 production manufactur\$4) with (high with frequency)).ab. and ((PCB CB PWB ((wiring circuit) adj board) circuitboard) and ((check\$4 accept\$4 reject\$4 confirm\$9 verif\$9 correct\$4 proper\$4 approv\$7 inspect\$4 camera scan\$4) with (conduct\$4 material properties characteristics)) and ((inspect\$4 camera scan\$4) with (PCB CB PWB ((wiring circuit) adj board) circuitboard))	US-PGPUB; USPAT	OR	ON	2009/01/29 17:24
S48	5	((assembl\$4 fabricat\$4 production manufactur\$4) with (high with frequency)).ab. and ((inspect\$4 camera scan\$4) with (PCB CB PWB ((wiring circuit) adj board) circuitboard))	US-PGPUB; USPAT	OR	ON	2009/01/29 17:25
S49	8	((assembl\$4 fabricat\$4 production manufactur\$4) with (high with frequency)).ab. and ((inspect\$4 camera scan\$4) same (PCB CB PWB ((wiring circuit) adj board) circuitboard))	US-PGPUB; USPAT	OR	ON	2009/01/29 17:27

S50	148	((assembl\$4 fabricat\$4 production manufactur\$4) with (high with frequency)).bsum. and ((inspect\$4 camera scan\$4) same (PCB CB PWB ((wiring circuit) adj board) circuitboard))	US-PGPUB; USPAT	OR	ON	2009/01/29 17:28
S51	271	((assembl\$4 fabricat\$4 production manufactur\$4) same (high with frequency)) and ((inspect\$4 camera scan\$4) same (PCB CB PWB ((wiring circuit) adj board) circuitboard) same (conduct\$4 material properties characteristics))	US-PGPUB; USPAT	OR	ON	2009/01/29 17:56
S52	214	((assembl\$4 fabricat\$4 production manufactur\$4) same (high with frequency)) and ((inspect\$4 camera scan\$4) same (PCB CB PWB ((wiring circuit) adj board) circuitboard) same (conduct\$4 material properties characteristics)) not S50	US-PGPUB; USPAT	OR	ON	2009/01/29 17:57
S53	36	((assembl\$4 fabricat\$4 production manufactur\$4) same (high with frequency)) and ((inspect\$4 camera scan\$4) with (PCB CB PWB ((wiring circuit) adj board) circuitboard) with (conduct\$4 material properties characteristics)) not S50	US-PGPUB; USPAT	OR	ON	2009/01/29 18:04

S54	90	((assembl\$4 fabricat\$4 production manufactur\$4 mount\$4 connect\$4) same (high with frequency)) and ((inspect\$4 camera scan\$4) with (PCB CB PWB ((wiring circuit) adj board) circuitboard) with (conduct\$4 material properties characteristics) not (S53 S50)	US-PGPUB; USPAT	OR	ON	2009/01/29 18:15
S55	90	((assembl\$4 fabricat\$4 production manufactur\$4 mount\$4 connect\$4) same (high with frequency)) and ((inspect\$4 camera scan\$4) with (PCB CB PWB ((wiring circuit) adj board) circuitboard) with (conduct\$4 material properties characteristics)) and ((deci\$4 whether reject\$4 accept\$4 verif\$9 confirm\$9 correct judg\$4 determin\$5 elect\$4 select\$4 choos\$4) with (PCB CB PWB ((wiring circuit) adj board) circuitboard) same (inspect\$4 camera scan\$4))	US-PGPUB; USPAT	OR	ON	2009/01/29 18:31
S56	74	((assembl\$4 fabricat\$4 production manufactur\$4 mount\$4 connect\$4) same (high with frequency)) and ((inspect\$4 camera scan\$4) with (PCB CB PWB ((wiring circuit) adj board) circuitboard) with (conduct\$4 material properties characteristics)) and ((deci\$4 whether reject\$4 accept\$4 verif\$9 confirm\$9 correct judg\$4 determin\$5 elect\$3 select\$4 choos\$4) with (PCB CB PWB ((wiring circuit) adj board))	US-PGPUB; USPAT	OR	ON	2009/01/29 18:34

		circuitboard) same (inspect\$4 camera scan \$4))				
S57	34	((assembl\$4 fabricat\$4 production manufactur \$4 mount\$4 connect \$4) same (high with frequency)) and ((inspect\$4 camera scan\$4) with (PCB CB PWB ((wiring circuit) adj board) circuitboard) with (conduct\$4 material properties characteristics)) and ((decisi\$4 whether reject \$4 accept\$4 verif\$9 confirm\$9 correct judg \$4 determin\$5 select\$4 choos\$4) with (PCB CB PWB ((wiring circuit) adj board) circuitboard) same (inspect\$4 camera scan\$4))	US-PGPUB; USPAT	OR	ON	2009/01/29 18:37
S58	2	((assembl\$4 fabricat\$4 production manufactur \$4 mount\$4 connect \$4) same (high with frequency)).ab. and ((inspect\$4 camera scan\$4) with (PCB CB PWB ((wiring circuit) adj board) circuitboard) with (conduct\$4 material properties characteristics)) and ((decisi\$4 whether reject \$4 accept\$4 verif\$9 confirm\$9 correct judg \$4 determin\$5 select\$4 choos\$4) with (PCB CB PWB ((wiring circuit) adj board) circuitboard) same (inspect\$4 camera scan\$4))	US-PGPUB; USPAT	OR	ON	2009/01/29 18:42

S59	34	((assembl\$4 fabricat\$4 production manufactur\$4 mount\$4 connect\$4) same (high with frequency)) and ((inspect\$4 camera scan\$4) with (PCB CB PWB ((wiring circuit) adj board) circuitboard) with (conduct\$4 material properties characteristics)) and ((deci\$4 whether reject\$4 accept\$4 verif\$9 confirm\$9 correct judg\$4 determin\$5 select\$4 choos\$4) with (PCB CB PWB ((wiring circuit) adj board) circuitboard) same (inspect\$4 camera scan\$4))	US-PGPUB; USPAT	OR	ON	2009/01/29 18:43
S60	118	((assembl\$4 fabricat\$4 production manufactur\$4 mount\$4 connect\$4) same (high with frequency)) and ((inspect\$4 camera scan\$4 test\$4 examin\$7) with (PCB CB PWB ((wiring circuit) adj board) circuitboard) with (conduct\$4 material properties characteristics)) and ((deci\$4 whether reject\$4 accept\$4 verif\$9 confirm\$9 correct judg\$4 determin\$5 select\$4 choos\$4) with (PCB CB PWB ((wiring circuit) adj board) circuitboard) same (inspect\$4 camera scan\$4 test\$4 examin\$7)) not S59	US-PGPUB; USPAT	OR	ON	2009/01/29 18:50

S61	152	((assembl\$4 fabricat\$4 production manufatur\$4 mount\$4 connect\$4) same (high with frequency)) and ((inspect\$4 camera scan\$4 test\$4 examin\$7) with (PCB CB PWB ((wiring circuit) adj board) circuitboard) with (conduct\$4 material properties characteristics)) and ((deci\$4 whether reject\$4 accept\$4 verif\$9 confirm\$9 correct judg\$4 determin\$5 select\$4 choos\$4) with (PCB CB PWB ((wiring circuit) adj board) circuitboard) same (inspect\$4 camera scan\$4 test\$4 examin\$7))	US-PGPUB; USPAT	OR	ON	2009/01/29 18:58
S62	11	((assembl\$4 fabricat\$4 production manufatur\$4 mount\$4 connect\$4) same (high with frequency)) and ((inspect\$4 camera scan\$4 test\$4 examin\$7) with (PCB CB PWB ((wiring circuit) adj board) circuitboard) with (conduct\$4 material properties characteristics)) and ((deci\$4 whether reject\$4 accept\$4 verif\$9 confirm\$9 correct judg\$4 determin\$5 select\$4 choos\$4) with (PCB CB PWB ((wiring circuit) adj board) circuitboard) same (inspect\$4 camera scan\$4 test\$4 examin\$7)) and camera	US-PGPUB; USPAT	OR	ON	2009/07/31 16:32

S63	10	((assembl\$4 fabricat\$4 production manufatur\$4 mount\$4 connect\$4) same (high with frequency)) and ((inspect\$4 camera scan\$4 test\$4 examin\$7) with (PCB CB PWB ((wiring circuit) adj board) circuitboard) with (conduct\$4 material properties characteristics)) and ((deci\$4 whether reject\$4 accept\$4 verif\$9 confirm\$9 correct judg\$4 determin\$5 select\$4 choos\$4) with (PCB CB PWB ((wiring circuit) adj board) circuitboard) same (inspect\$4 camera scan\$4 test\$4 examin\$7)) and camera and (plac\$5 mount\$4)	US-PGPUB; USPAT	OR	ON	2009/07/31 16:33
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8/ 3/ 09 10:14:55 AM

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